

### **Features**

- Top view 1206 package
- Viewing Angle = ±70°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Yellow
- RoHS compliance

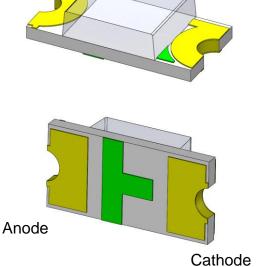
## **Applications**

- Optical indicator.
- Switch and Symbol Display.

## **Description**

The YP321608-ATC3 is an AlGaInP Yellow LED housed in a miniature SMD package. The device has a dominant wavelength of 590nm LED.

## **Package Outline**



### **Schematic**

Cathode 
$$\longrightarrow$$
 Anode  $(-)$ 



## Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
I <sub>FP</sub>	Peak Forward Current	60	mA	1
V <sub>R</sub>	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	°C	
T <sub>sol</sub>	Soldering Temperature	260	°C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	65	mW	

## Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =20mA	89	-	250	mcd	3
λd	Dominant Wavelength	I <sub>F</sub> =20mA	586	-	594	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =20mA	•	±70	1	deg	

### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =20mA	1.7	-	2.5	V	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μΑ	

### Notes:

- 1. I<sub>FP</sub> Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time  $\leq 10$  seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
n1	89	100		
n2	100	130		
01	130	160	mcd	I <sub>F</sub> =20mA
02	160	200		
p1	200	250		

Tolerance of Luminous Intensity  $\pm 10\%$ 



### 4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition	
YB1	586	588		I <sub>F</sub> =20mA	
YB2	588	590			
YB3	590	592	nm		
YB4	592	594			

Tolerance of Dominant Wavelength:  $\pm 1\,\text{nm}$ .

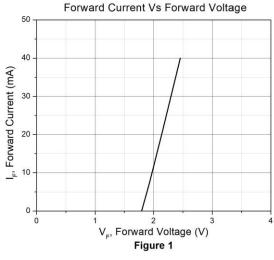
#### 5. Bin Range of Forward Voltage

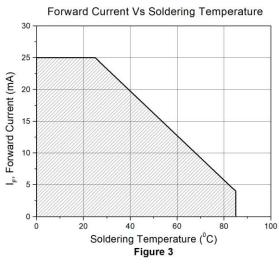
Bin Code	Min	Max	Unit	Condition	
V4	1.7	1.9		I <sub>F</sub> =20mA	
V5	1.9	2.1	V		
V6	2.1	2.3	V		
V7	2.3	2.5			

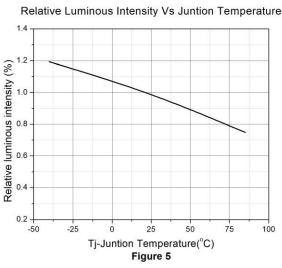
Tolerance of Forward Voltage  $\pm 0.1$ V.

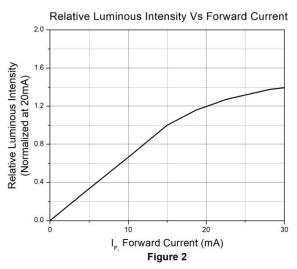


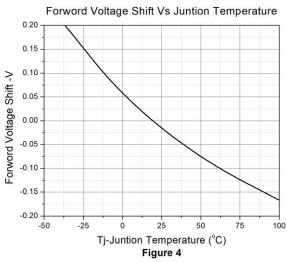
## **Typical Characteristic Curves**

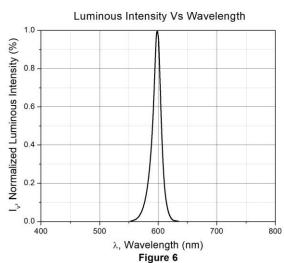






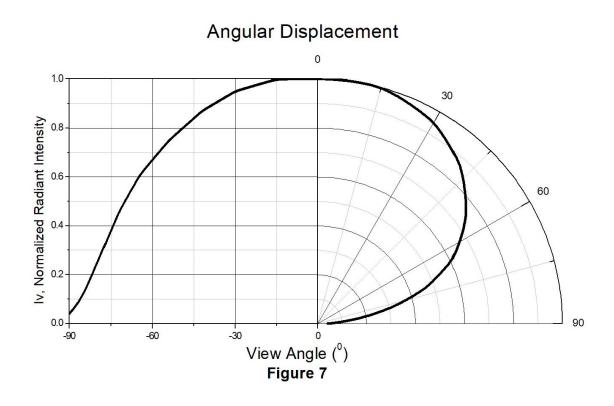






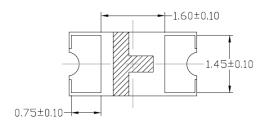


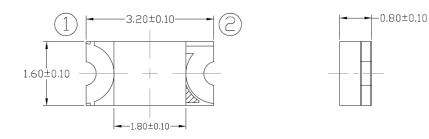
## **Typical Characteristic Curves**

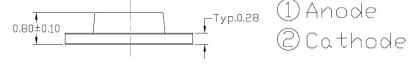




## Package Dimension All dimensions are in mm, unless otherwise stated

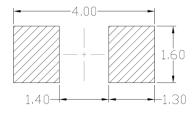






Note: Tolerance unless mentioned is ±0.1mm.

## Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



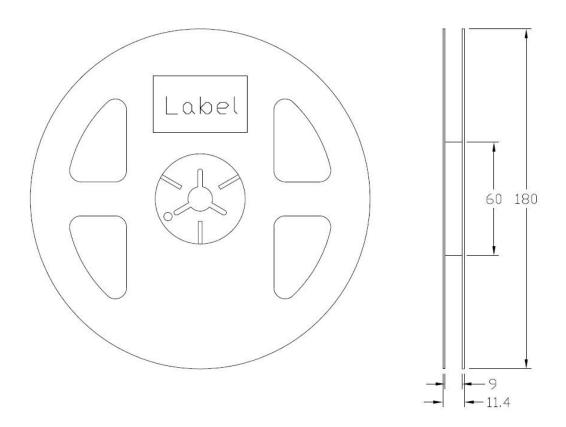
Note: Tolerance unless mentioned is ±0.1mm.

## **Ordering Information**

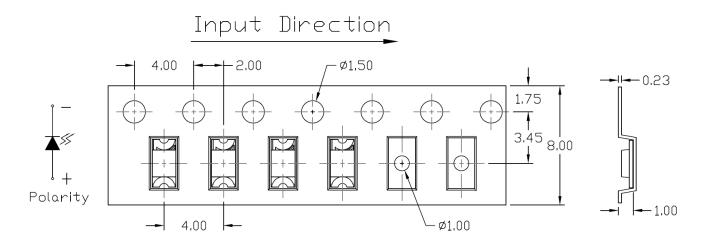
Part Number	Description	Quantity
YP321608-ATC3	Tape & Reel	3000 pcs



## Reel Dimension All dimensions are in mm, unless otherwise stated



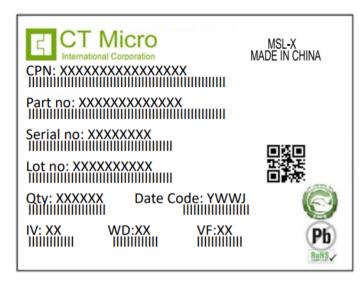
## Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



### **Label Form Specification**



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

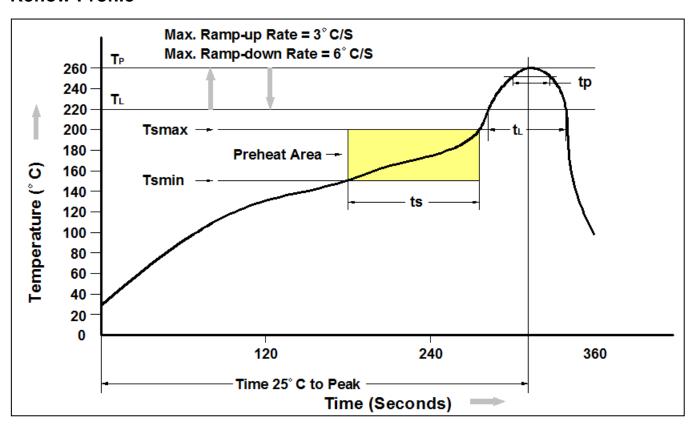
MADE IN CHINA: Production Place

### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.